

**AUTOMOTIVE-COMPLIANT, 5.5V INPUT, 2A LOW IQ
 SYNCHRONOUS BUCK CONVERTER**

Description

The AP61204Q is an automotive-compliant, 2A, synchronous buck converter with a wide input-voltage range of 2.4V to 5.5V. The device fully integrates a 70mΩ high-side power MOSFET and a 50mΩ low-side power MOSFET to provide high-efficiency step-down DC-DC conversion.

The AP61204Q device is easily used by minimizing the external component count due to its adoption of Constant On-Time (COT) control to achieve fast transient response, easy loop stabilization, and low output-voltage ripple.

The device is available in a SOT563 package.

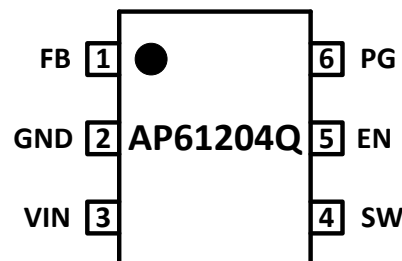
Features

- AEC-Q100 Qualified for Automotive Applications
 - Device Temperature Grade 1: -40°C to +125°C T_A Range
- VIN: 2.4V to 5.5V
- Output Voltage (V_{OUT}): 0.6V to VIN
- 2A Continuous Output Current
- 0.6V ± 2% Reference Voltage
- 19μA Low Quiescent Current (Pulse-Frequency Modulation)
- 2.4MHz Switching Frequency (VIN = 5V, V_{OUT} = 1.8V)
- Up to 84% Efficiency at 5mA Light Load
- Programmable Operation Mode Through EN
 - Pulse-Frequency Modulation
 - Pulse-Width Modulation Regardless of Output Load
- Low-Dropout (LDO) Mode
- Power-Good Indicator
- Protection Circuitry
 - Undervoltage Lockout (UVLO)
 - VIN Overvoltage Protection (OVP)
 - Peak Current Limit
 - Valley Current Limit
 - Thermal Shutdown
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The AP61204Q is suitable for automotive applications requiring specific change control; this part is AEC-Q100 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.**

<https://www.diodes.com/quality/product-definitions/>

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Assignments



SOT563

Applications

- Automotive power systems
- Automotive infotainment
- Automotive instrument clusters
- Automotive telematics
- Advanced driver assistance systems

Typical Application Circuit

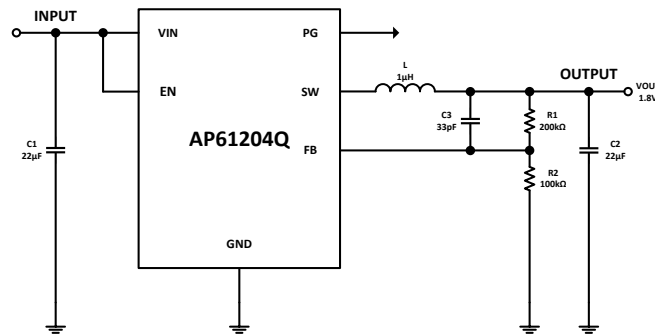


Figure 1. Typical AP61204Q Application Circuit

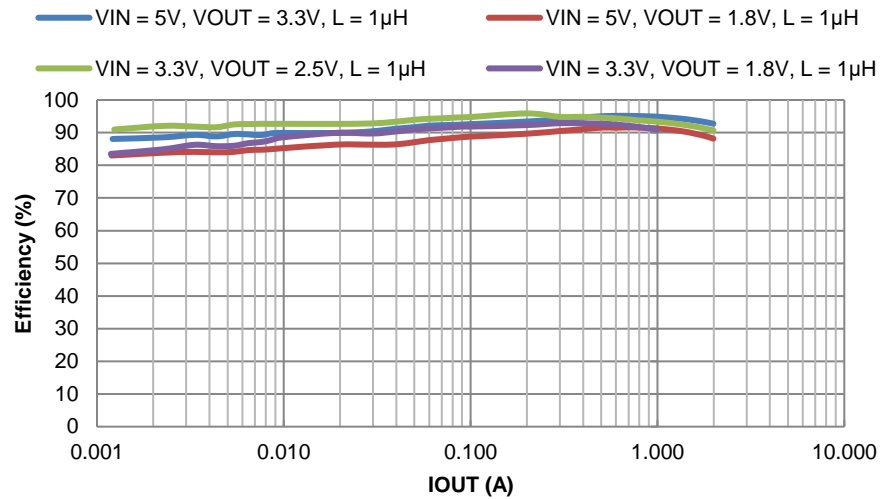


Figure 2. PFM Efficiency vs. Output Current

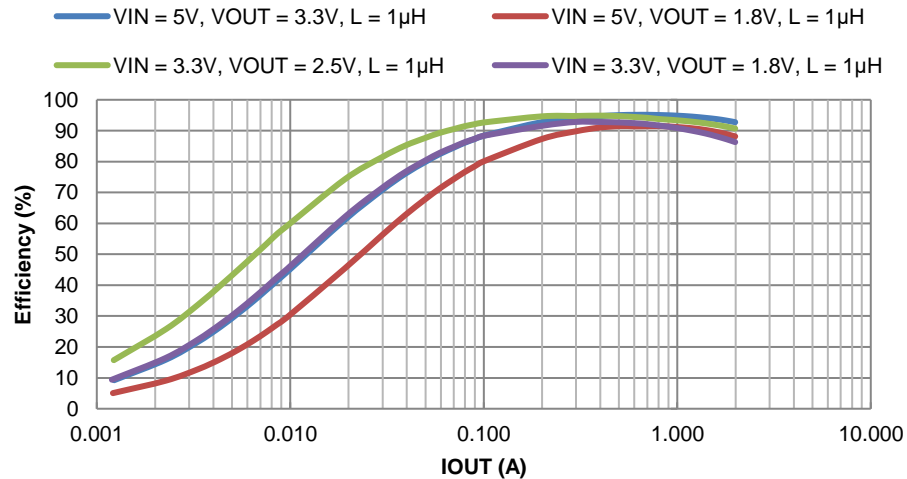


Figure 3. PWM Efficiency vs. Output Current

Pin Descriptions

Pin Name	Pin Number	Function
FB	1	Feedback sensing terminal for the output voltage. Connect this pin to the resistive divider of the output. See <i>Setting the Output Voltage</i> section for more details.
GND	2	Power Ground.
VIN	3	Power Input. VIN supplies the power to the IC as well as the step-down converter power MOSFETs. Drive VIN with a 2.4V to 5.5V power source. Bypass VIN to GND with a suitably large capacitor to eliminate noise due to the switching of the IC. See <i>Input Capacitor</i> section for more details.
SW	4	Power Switching Output. SW is the switching node that supplies power to the output. Connect the output LC filter from SW to the output load.
EN	5	Enable Input. EN is a digital input that turns the regulator on or off. Drive EN high to turn on the regulator and low to turn it off. EN is used to program the Operation Mode (PFM or PWM). See <i>Enable</i> section for more details.
PG	6	Power-Good. Open-drain power-good output that is pulled to GND when the output voltage is out of its regulation limits or during soft-start.

Functional Block Diagram

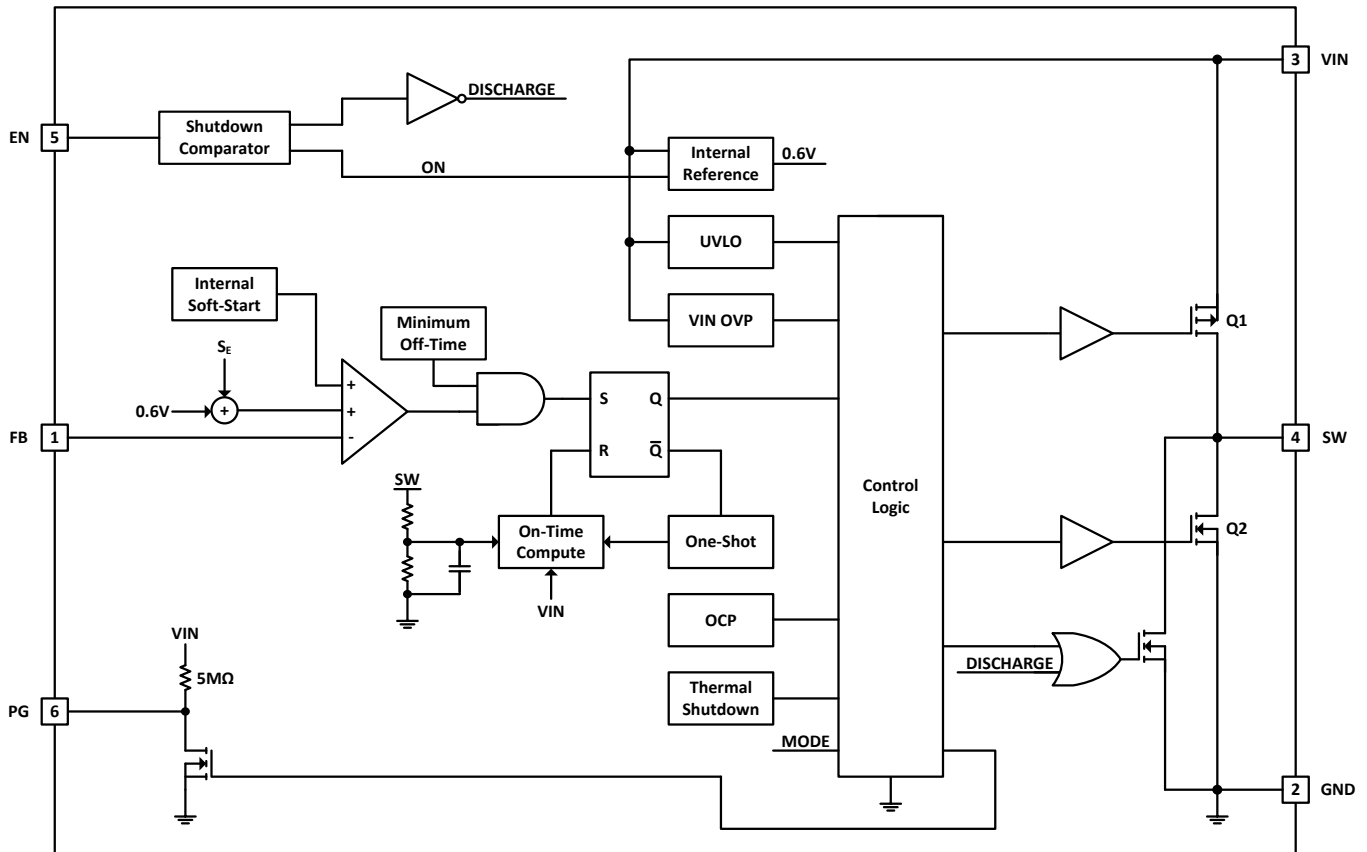


Figure 4. Functional Block Diagram

Absolute Maximum Ratings (Note 4) (@ T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
VIN	Supply Pin Voltage	-0.3 to +6.5 (DC)	V
		-0.3 to +7.0 (400ms)	
V _{FB}	Feedback Pin Voltage	-0.3 to VIN + 0.3	V
V _{SW}	Switch Pin Voltage	-1.0 to VIN + 0.3 (DC)	V
		-2.5 to VIN + 2.0 (20ns)	
V _{EN}	Enable Pin Voltage	-0.3 to VIN + 0.3	V
V _{PG}	Power-Good Pin Voltage	-0.3 to +6.0 (DC)	V
T _{ST}	Storage Temperature	-65 to +150	°C
T _J	Junction Temperature	+160	°C
T _L	Lead Temperature	+260	°C
ESD Susceptibility (Note 5)			
HBM	Human Body Model	±4000	V
CDM	Charged Device Model	±1500	V

- Notes:
- Stresses greater than those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to *Absolute Maximum Ratings* for extended periods can affect device reliability.
 - Semiconductor devices are ESD sensitive and can be damaged by exposure to ESD events. Suitable ESD precautions should be taken when handling and transporting these devices.

Thermal Resistance (Note 6)

Symbol	Parameter	JEDEC (Note 6)	EVM (Note 7)	Unit
θ _{JA}	Junction to Ambient	141	60	°C/W
θ _{JC}	Junction to Case	33	33	°C/W

- Notes:
- Test condition for SOT563: device mounted on FR-4 substrate, two-layer PCB, 2oz copper, with minimum recommended pad layout.
 - Device mounted on Diodes Incorporated's evaluation board.

Recommended Operating Conditions (Note 8) (@ T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Min	Max	Unit
VIN	Supply Voltage	2.4	5.5	V
VOUT	Output Voltage	0.6	VIN	V
T _J	Operating Junction Temperature	-40	+150	°C

- Note:
- The device function is not guaranteed outside of the recommended operating conditions.

Electrical Characteristics (@ $T_J = +25^\circ\text{C}$, $V_{IN} = 5\text{V}$, unless otherwise specified. Min/Max limits apply across the recommended operating junction temperature range, -40°C to $+150^\circ\text{C}$, and input-voltage range, 2.4V to 5.5V, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
ISHDN	Shutdown Supply Current	$V_{EN} = 0\text{V}$	—	0.1	—	μA
I_Q	Quiescent Supply Current	PFM, $V_{FB} = 0.65\text{V}$	—	19	—	μA
		PWM, $V_{FB} = 0.65\text{V}$	—	690	—	μA
POR	VIN Power-on Reset Rising Threshold	—	—	2.3	2.4	V
UVLO	VIN Undervoltage Lockout Falling Threshold	—	—	2.2	—	V
OVP _{VIN}	VIN Overvoltage Rising Threshold	—	—	6.3	—	V
OVP _{VIN_HYS}	VIN Overvoltage Hysteresis	—	—	300	—	mV
R _{DS(ON)1}	High-Side Power MOSFET On-Resistance (Note 9)	—	—	70	—	m Ω
R _{DS(ON)2}	Low-Side Power MOSFET On-Resistance (Note 9)	—	—	50	—	m Ω
I _{PEAK_LIMIT}	HS Peak Current Limit (Note 9)	From Source to Drain	2.4	3.0	3.6	A
I _{VALLEY_LIMIT}	LS Valley Current Limit (Note 9)	From Source to Drain	—	2.6	—	A
f _{SW}	Oscillator Frequency	$V_{OUT} = 1.8\text{V}$, CCM	1.9	2.4	2.9	MHz
t _{ON_MIN}	Minimum On-Time	—	—	70	—	ns
t _{OFF_MIN}	Minimum Off-Time	—	—	70	—	ns
V _{FB}	Feedback Voltage	CCM	0.588	0.600	0.612	V
V _{EN_H}	EN Logic-High Threshold	—	—	0.91	—	V
V _{EN_L}	EN Logic-Low Threshold	—	—	0.83	—	V
t _{SS}	Soft-Start Time	—	—	0.5	—	ms
PG _{UV_FALL}	Undervoltage Falling Threshold	Percent of Output Regulation, Fault	—	90	—	%
PG _{UV_RISE}	Undervoltage Rising Threshold	Percent of Output Regulation, Good	—	95	—	%
PG _{OV_RISE}	Overvoltage Rising Threshold	Percent of Output Regulation, Fault	—	110	—	%
PG _{OV_FALL}	Overvoltage Falling Threshold	Percent of Output Regulation, Good	—	105	—	%
t _{PG_RD}	Power-Good Falling Delay Time	—	—	40	—	μs
V _{PG_OL}	Power-Good Output Logic Low	$I_{PG} = -1\text{mA}$	—	—	0.4	V
R _{PG}	Power-Good Pullup Resistor	—	—	5	—	M Ω
T _{SD}	Thermal Shutdown (Note 9)	—	—	+160	—	$^\circ\text{C}$
T _{Hys}	Thermal Shutdown Hysteresis (Note 9)	—	—	+30	—	$^\circ\text{C}$

Note: 9. Compliance to the datasheet limits is assured by one or more methods: production test, characterization, and/or design.

Typical Performance Characteristics (AP61204Q @ $T_A = +25^\circ\text{C}$, $V_{IN} = 5\text{V}$, $V_{OUT} = 1.8\text{V}$, BOM = Table 1, unless otherwise specified.)

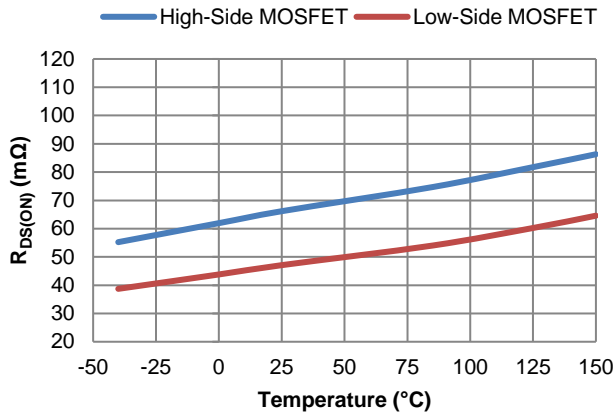


Figure 5. Power MOSFET $R_{DS(on)}$ vs. Temperature

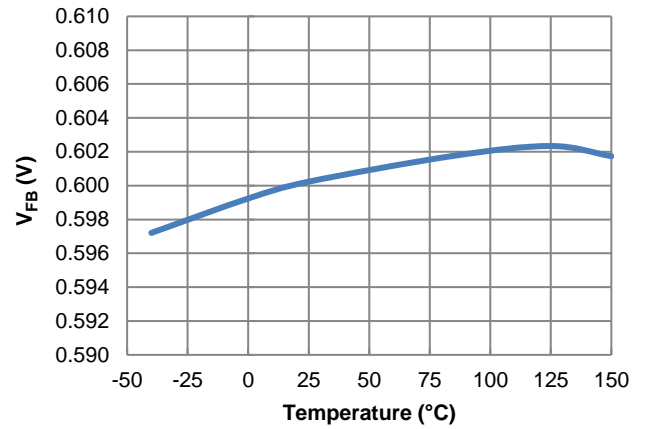


Figure 6. V_{FB} vs. Temperature, $I_{OUT} = 1\text{A}$

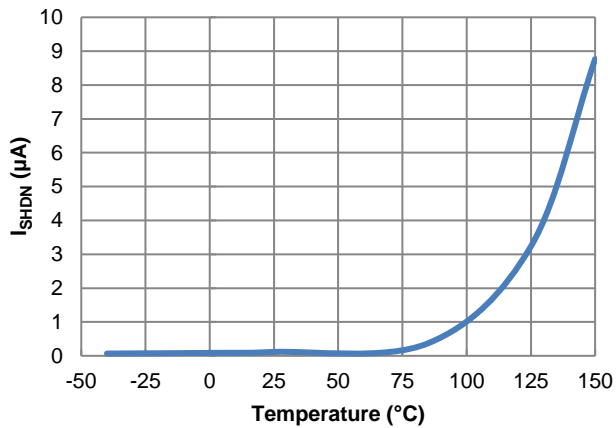


Figure 7. I_{SHDN} vs. Temperature

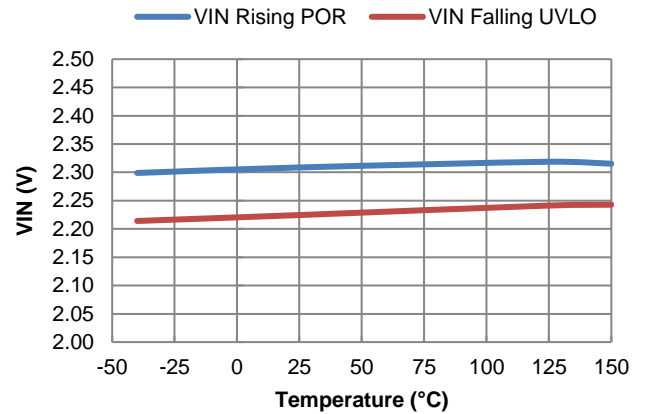


Figure 8. VIN Power-On Reset and UVLO vs. Temperature

Typical Performance Characteristics (AP61204Q @ $T_A = +25^\circ\text{C}$, $V_{IN} = 5\text{V}$, $V_{OUT} = 1.8\text{V}$, BOM = Table 1, PFM, unless otherwise specified.)

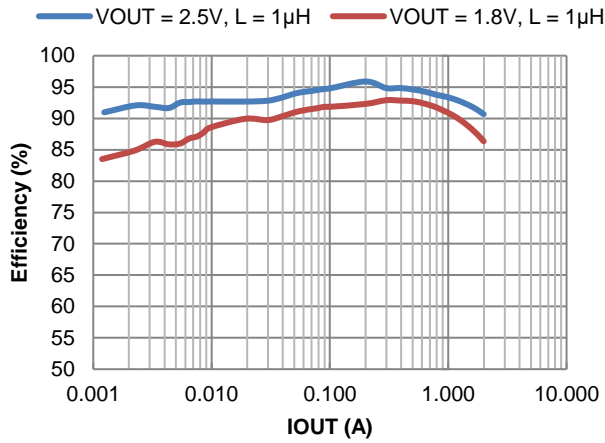


Figure 9. Efficiency vs. Output Current, $V_{IN} = 3.3\text{V}$

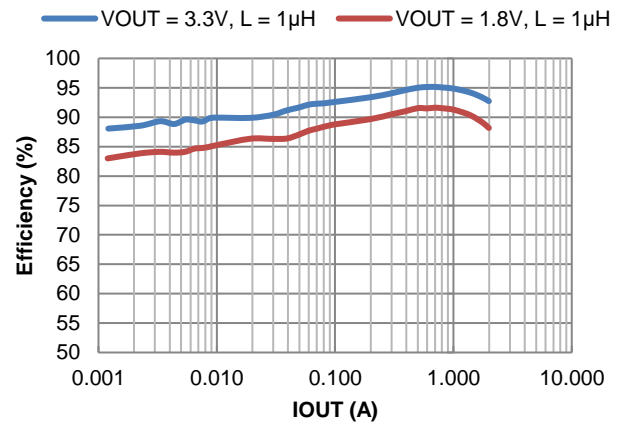


Figure 10. Efficiency vs. Output Current, $V_{IN} = 5\text{V}$

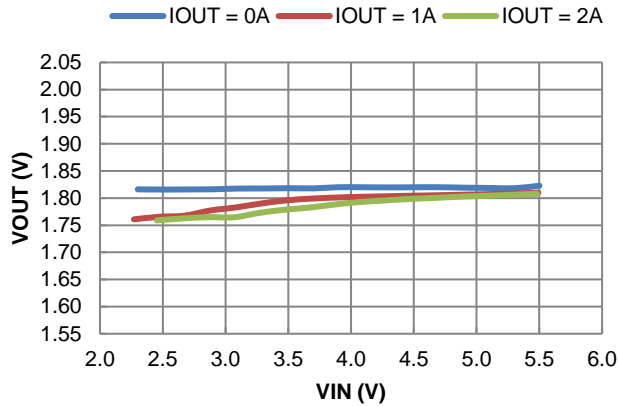


Figure 11. Line Regulation

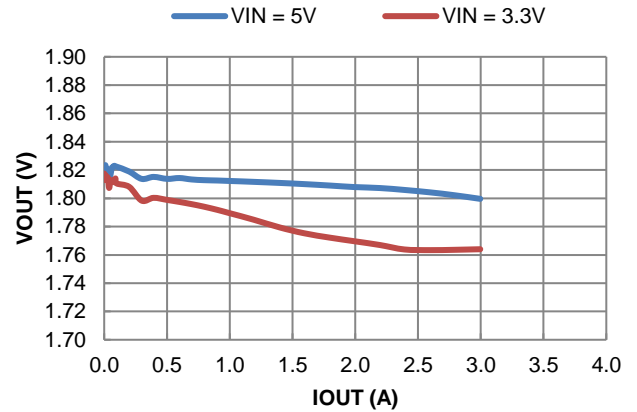


Figure 12. Load Regulation

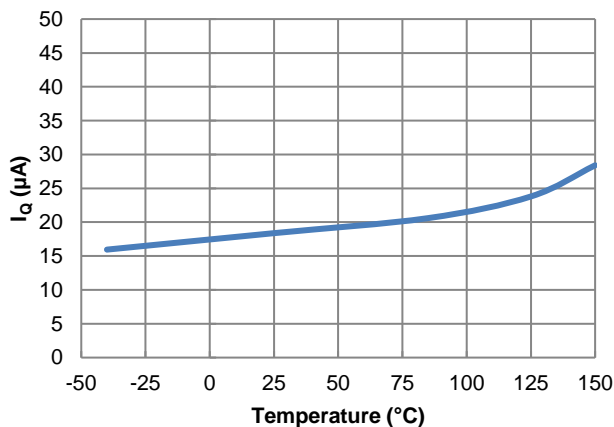


Figure 13. I_Q vs. Temperature

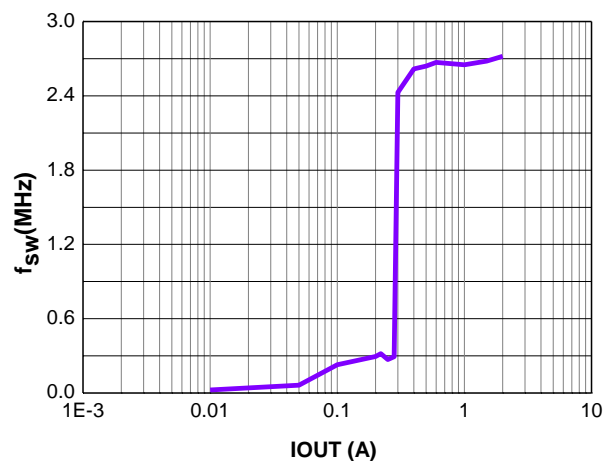


Figure 14. f_{sw} vs. Load

Typical Performance Characteristics (AP61204Q @ $T_A = +25^\circ\text{C}$, $V_{IN} = 5\text{V}$, $V_{OUT} = 1.8\text{V}$, BOM = Table 1, PFM, unless otherwise specified.) (continued)

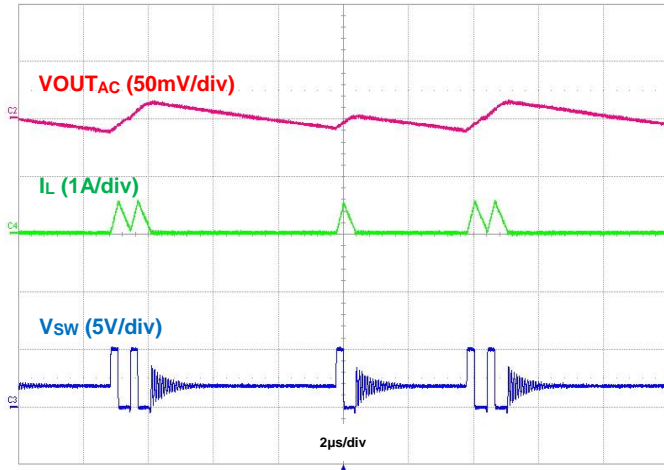


Figure 15. Output-Voltage Ripple, $I_{OUT} = 50\text{mA}$

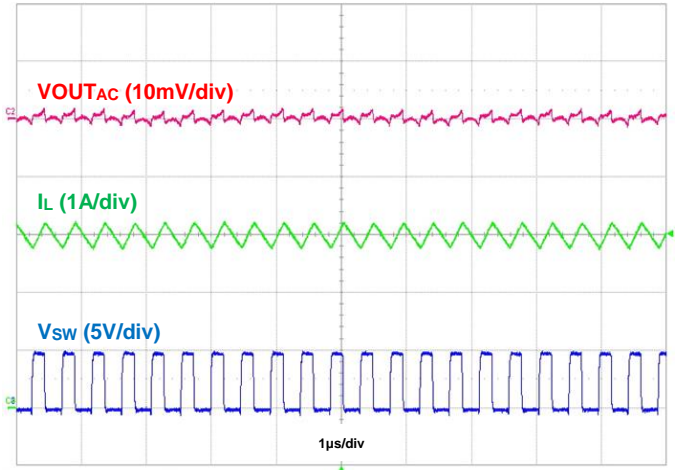


Figure 16. Output-Voltage Ripple, $I_{OUT} = 2\text{A}$

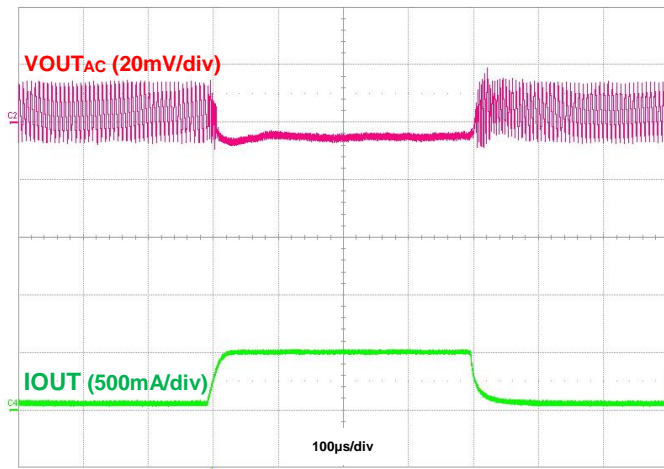


Figure 17. Load Transient, $I_{OUT} = 50\text{mA}$ to 500mA to 50mA

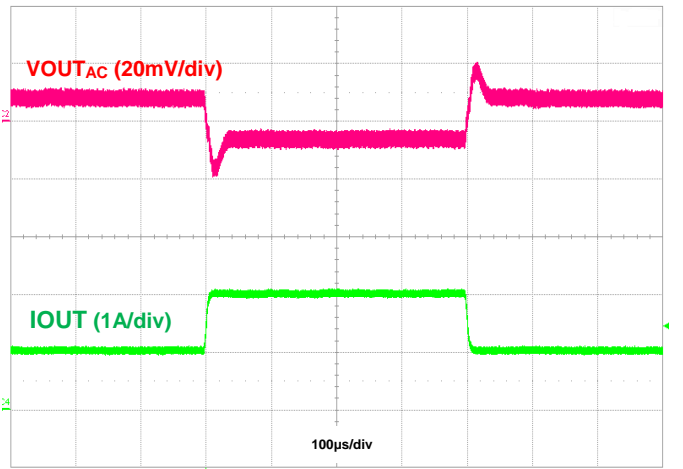


Figure 18. Load Transient, $I_{OUT} = 1\text{A}$ to 2A to 1A

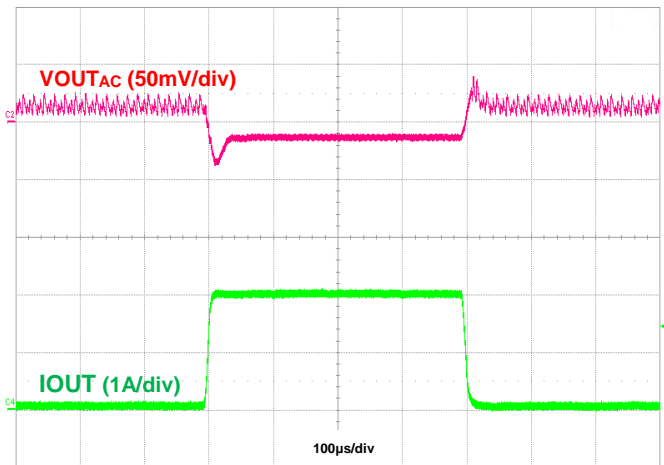


Figure 19. Load Transient, $I_{OUT} = 50\text{mA}$ to 2A to 50mA

Typical Performance Characteristics (AP61204Q @ $T_A = +25^\circ\text{C}$, $V_{IN} = 5\text{V}$, $V_{OUT} = 1.8\text{V}$, BOM = Table 1, PWM, unless otherwise specified.)

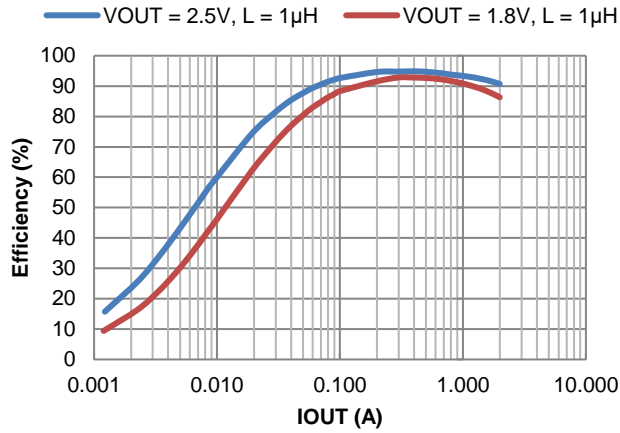


Figure 20. Efficiency vs. Output Current, $V_{IN} = 3.3\text{V}$

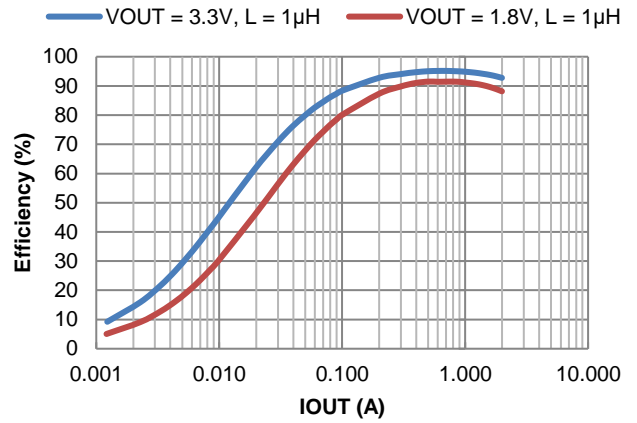


Figure 21. Efficiency vs. Output Current, $V_{IN} = 5\text{V}$

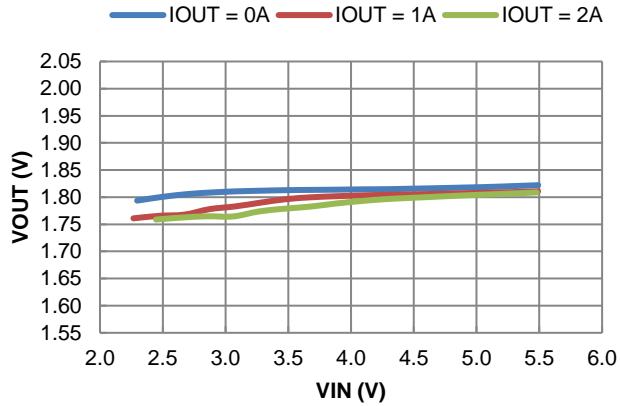


Figure 22. Line Regulation

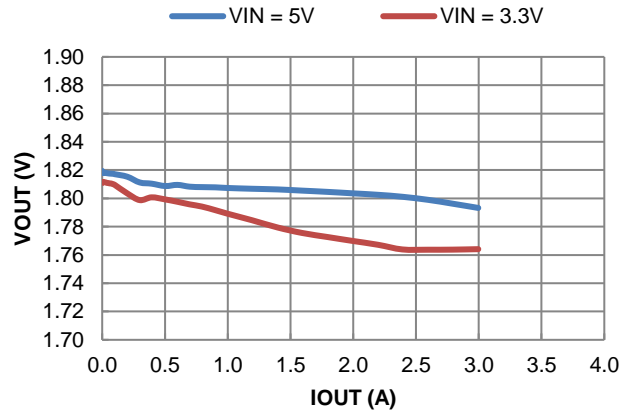


Figure 23. Load Regulation

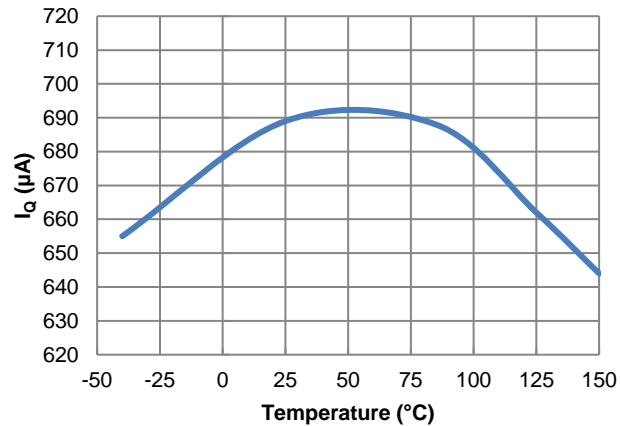


Figure 24. I_Q vs. Temperature

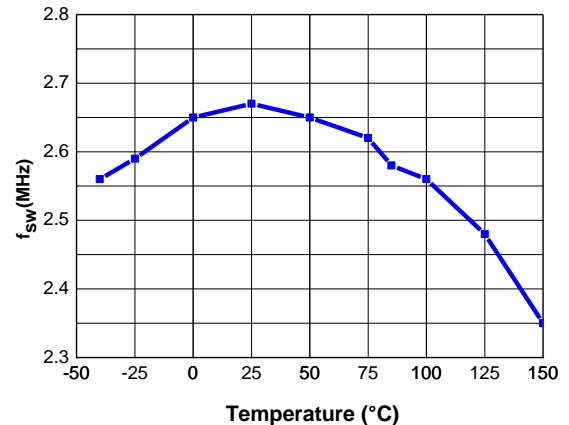


Figure 25. f_{sw} vs. Temperature, $I_{OUT} = 0\text{A}$

Typical Performance Characteristics (AP61204Q @ $T_A = +25^\circ\text{C}$, $V_{IN} = 5\text{V}$, $V_{OUT} = 1.8\text{V}$, BOM = Table 1, PWM, unless otherwise specified.) (continued)

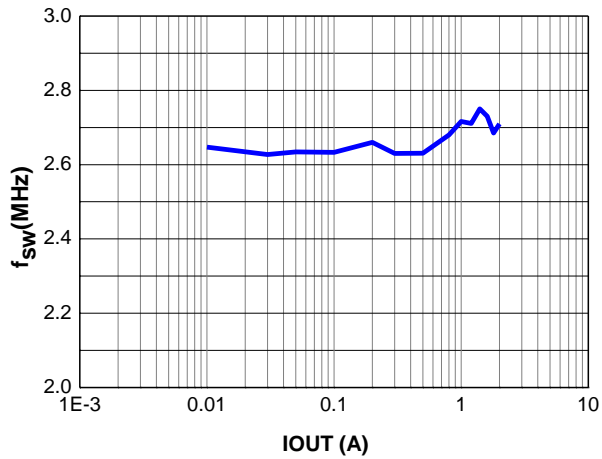


Figure 26. f_{sw} vs. Load

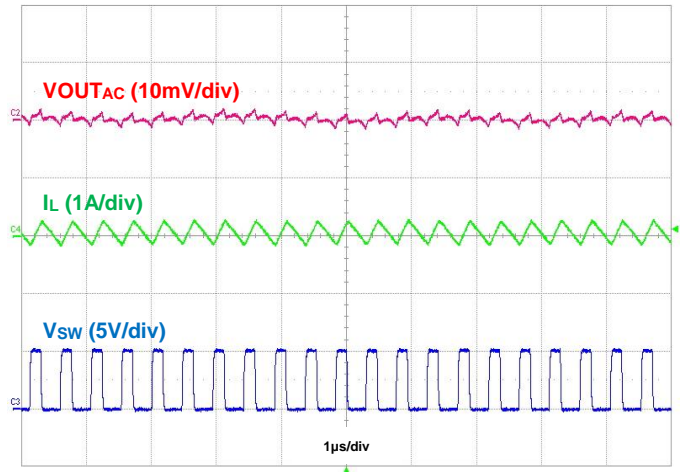


Figure 27. Output-Voltage Ripple, $I_{OUT} = 50\text{mA}$

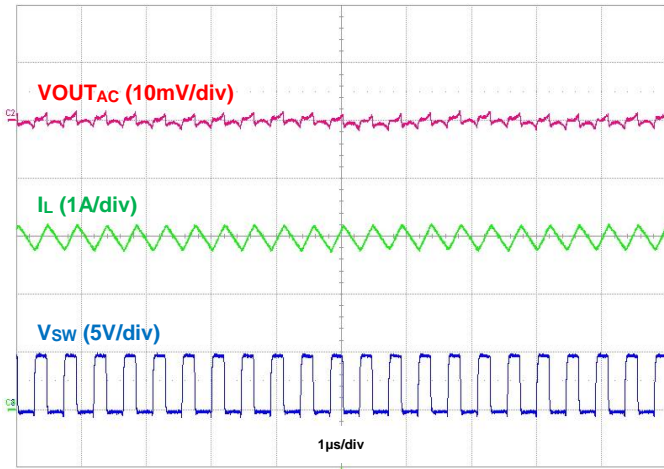


Figure 28. Output-Voltage Ripple, $I_{OUT} = 2\text{A}$

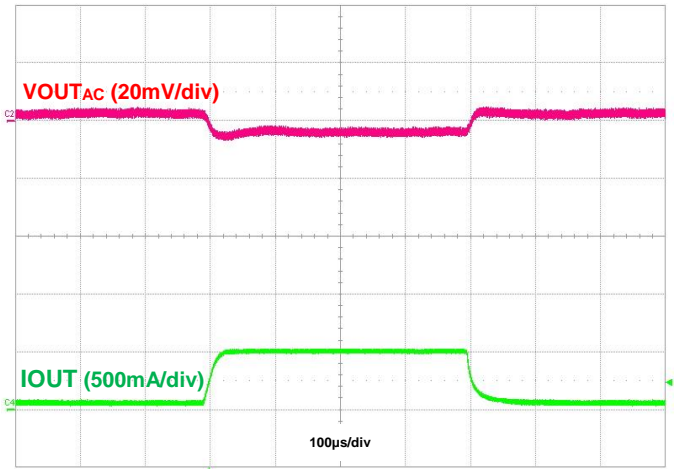


Figure 29. Load Transient, $I_{OUT} = 50\text{mA}$ to 500mA to 50mA

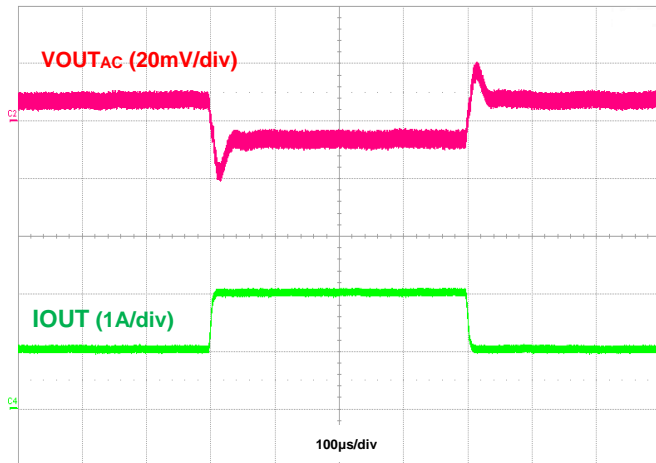


Figure 30. Load Transient, $I_{OUT} = 1\text{A}$ to 2A to 1A

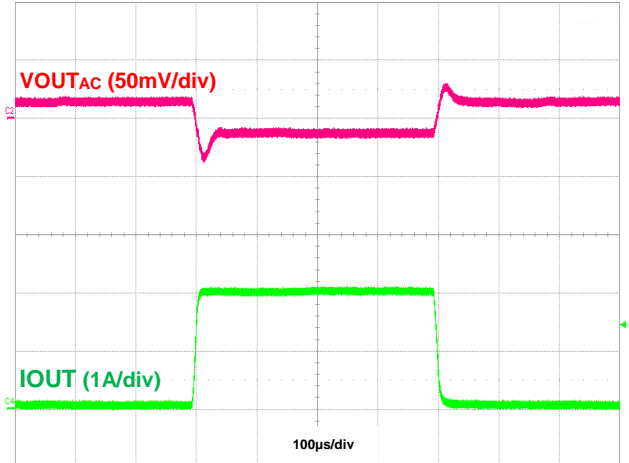


Figure 31. Load Transient, $I_{OUT} = 50\text{mA}$ to 2A to 50mA

Typical Performance Characteristics (AP61204Q @ $T_A = +25^\circ\text{C}$, $V_{IN} = 5\text{V}$, $V_{OUT} = 1.8\text{V}$, BOM = Table 1, unless otherwise specified.)

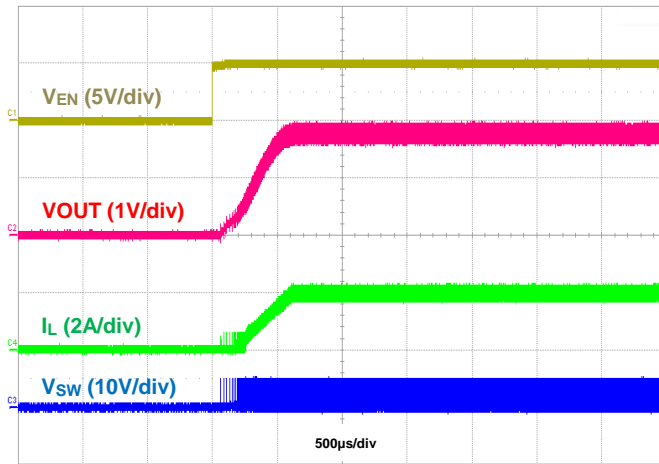


Figure 32. Startup Using EN, IOU = 2A

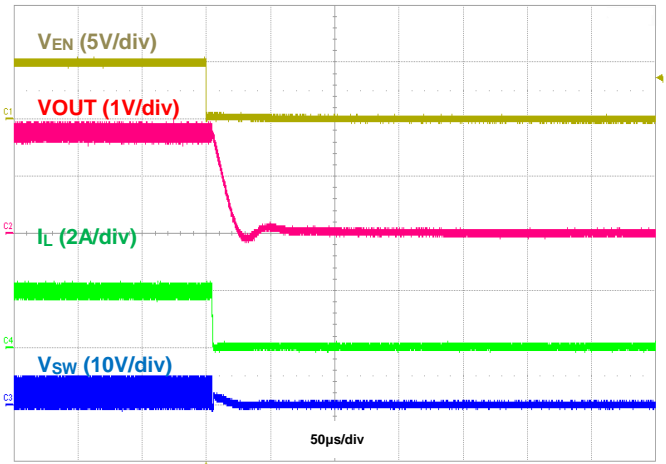


Figure 33. Shutdown Using EN, IOU = 2A

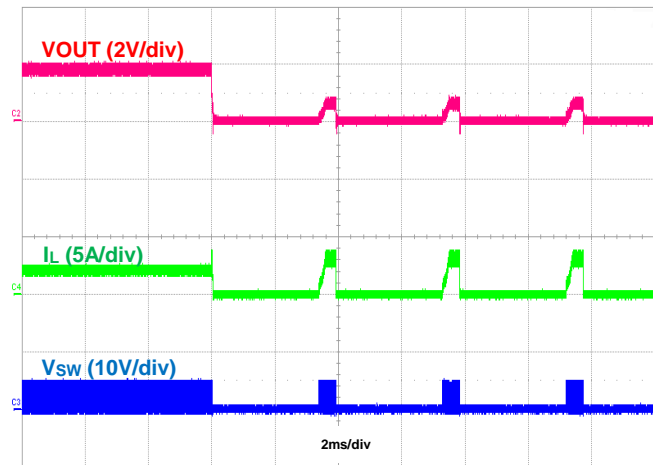


Figure 34. Output Short Protection, IOU = 2A

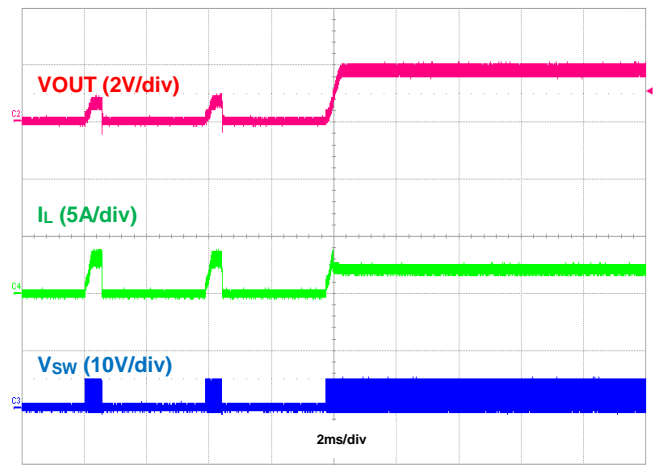


Figure 35. Output Short Recovery, IOU = 2A

Typical Performance Characteristics (AP61204Q @ $T_A = +25^\circ\text{C}$, $V_{IN} = 5\text{V}$, $V_{OUT} = 1.8\text{V}$, BOM = Table 1, unless otherwise specified.) (continued)

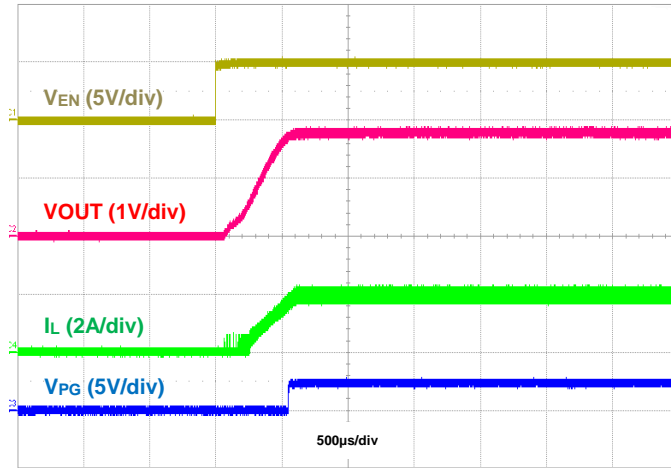


Figure 36. Startup Using EN, IOU = 2A

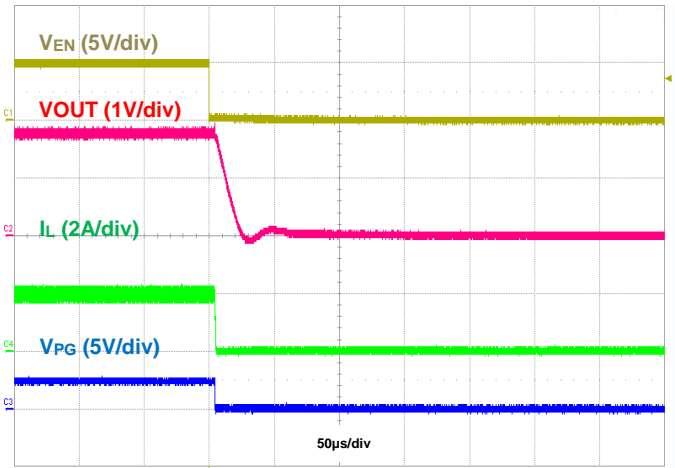


Figure 37. Shutdown Using EN, IOU = 2A

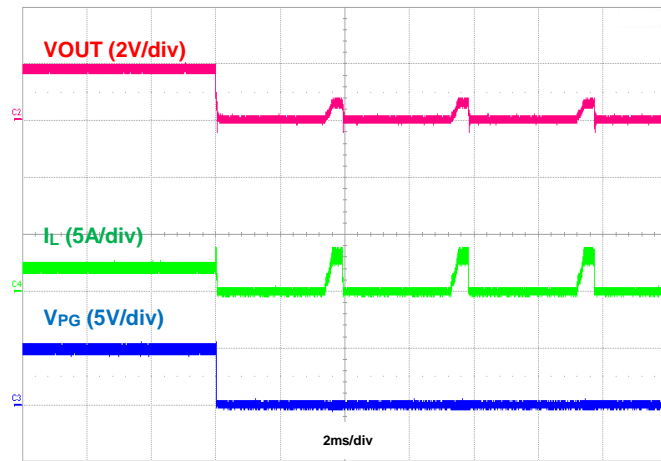


Figure 38. Output Short Protection, IOU = 2A

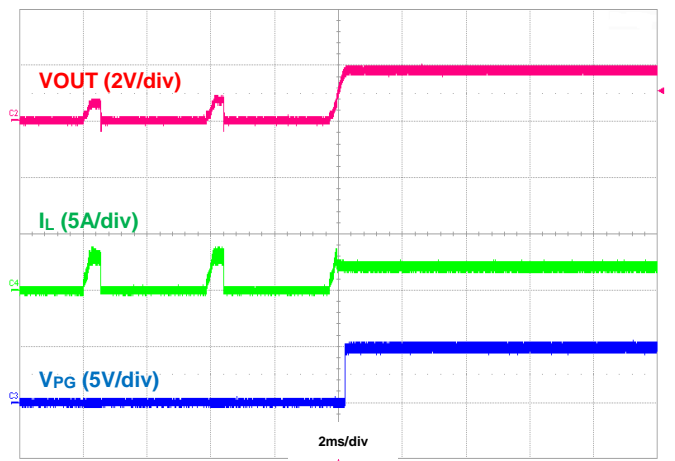


Figure 39. Output Short Recovery, IOU = 2A

Application Information

1 Pulse-Width Modulation (PWM) Operation

The AP61204Q device is an automotive-compliant, 2.4V-to-5.5V input, 2A output, fully integrated synchronous buck converter. Refer to the block diagram in Figure 4. The device employs constant on-time control to provide fast transient response and easy loop stabilization. At the beginning of each cycle, the one-shot pulse turns on the high-side power MOSFET, Q1, for a fixed on-time, t_{ON} . This one-shot on-pulse timing is calculated by the converter's input voltage and output voltage to maintain a pseudo-fixed frequency over the input-voltage range. When Q1 is on, the inductor current rises linearly and the device charges the output capacitor. Q1 turns off after the fixed on-time expires, and the low-side power MOSFET, Q2, turns on. Once the output voltage drops below the output regulation, Q2 turns off. The one-shot timer is then reset and Q1 turns on again. The on-time is inversely proportional to the input voltage and directly proportional to the output voltage. It is calculated by the following equation:

$$t_{ON} = \frac{V_{OUT}}{V_{IN} \cdot f_{SW}} \quad \text{Eq. 1}$$

Where:

- V_{IN} is the input voltage
- V_{OUT} is the output voltage
- f_{SW} is the switching frequency

The off-time duration is t_{OFF} and starts after the on-time expires. The off-time expires when the feedback voltage decreases below the reference voltage, which then triggers the on-time duration to start again. The minimum off-time is 70ns typical.

2 Pulse-Frequency Modulation (PFM) Operation

The AP61204Q can be programmed to enter PFM operation at light-load conditions for high efficiency. During light-load conditions, the regulator automatically reduces the switching frequency. As the output current decreases, so too does the inductor current. The inductor current, I_L , eventually reaches 0A, marking the boundary between Continuous Conduction Mode (CCM) and Discontinuous Condition Mode (DCM). During this time, both Q1 and Q2 are off, and the load current is provided only by the output capacitor. When V_{FB} becomes lower than 0.6V, the next cycle begins, and Q1 turns on. Because the AP61204Q can work in PFM during light-load conditions, it can achieve power efficiency of up to 84% at a 5mA load condition.

Likewise, as the output load increases from light load to heavy load, the switching frequency increases to maintain the regulation of the output voltage. The transition point between light and heavy-load conditions can be calculated using the following equation:

$$I_{LOAD} = \left(\frac{V_{IN} - V_{OUT}}{2L} \right) \cdot t_{ON} \quad \text{Eq. 2}$$

Where:

- L is the inductor value

The quiescent current of AP61204Q is 19μA typical under a no-load, non-switching condition.

Application Information (continued)

3 Enable

When disabled, the device shutdown supply current is only 0.1 μ A. When applying a voltage greater than the EN logic-high threshold (typical 0.91V, rising), the AP61204Q enables all functions and the device initiates the soft-start phase. The AP61204Q has a built-in 0.5ms soft-start time to prevent output-voltage overshoot and inrush current. When the EN voltage falls below its logic-low threshold (typical 0.83V, falling), the internal SS voltage discharges to ground and the device operation is disabled.

The device operates in PFM when a logic-high voltage is applied to the EN pin greater than $V_{IN} - 200\text{mV}$. Tying the EN pin to the VIN pin is sufficient to achieve this threshold condition.

The device operates in PWM regardless of output load when a logic-high voltage is applied to the EN pin less than $V_{IN} - 200\text{mV}$. Using an external resistive divider to create a difference in voltage between the VIN and EN pins is sufficient to achieve this threshold condition.

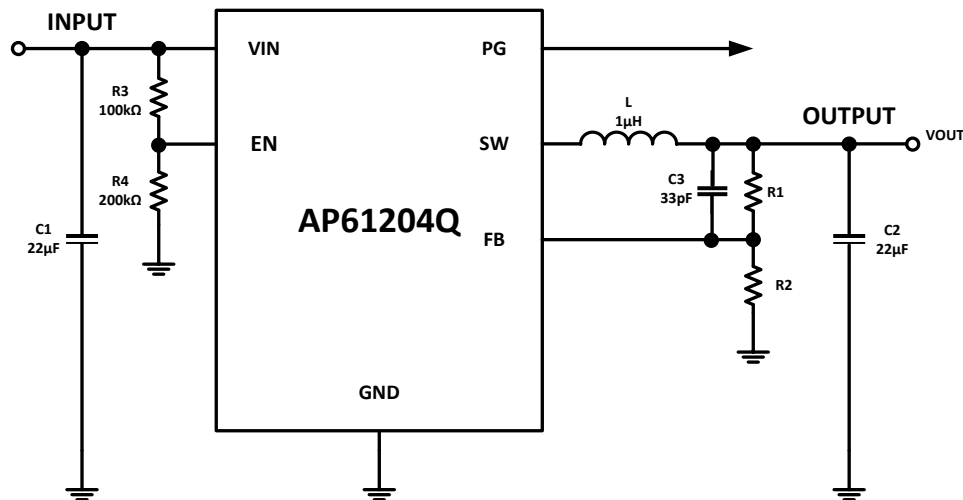


Figure 40. Example Application Circuit for Forced PWM Operation

4 Power-Good (PG) Indicator

The PG pin of AP61204Q is an open-drain output that is actively held low during the soft-start period until the output voltage reaches 95% of its target value. When the output voltage is outside of its regulation by $\pm 10\%$, PG pulls low until the output returns within 5% of its set value. The PG falling edge transition is delayed by 40 μ s. The PG pin is connected to VIN through an internal 5M Ω pullup resistor.

5 Undervoltage Lockout (UVLO) and Input Overvoltage Protection (OVP)

Undervoltage lockout is implemented to protect the IC from insufficient input voltages. The AP61204Q is disabled if the input voltage falls below 2.2V. In this UVLO event, both the high-side and low-side power MOSFETs turn off and the 125 Ω active discharge is enabled to discharge the output voltage to ground.

Similarly, input overvoltage protection is implemented to protect the IC from excess input voltages. The AP61204Q is disabled if the input voltage rises above 6.3V. In this OVP event, both the high-side and low-side power MOSFETs turn off and the 125 Ω active discharge is enabled to discharge the output voltage to ground.

Application Information (continued)

6 Overcurrent Protection (OCP)

The AP61204Q has cycle-by-cycle valley current limit protection by sensing the current through the internal low-side power MOSFET, Q2. While Q2 is on, the internal sensing circuitry monitors its conduction current. The overcurrent limit has a corresponding voltage limit, V_{LIMIT} . When the voltage between GND and SW is lower than V_{LIMIT} due to excessive current through Q2, the OCP is triggered, and the controller turns off Q2. During this time, both Q1 and Q2 remain off. A new switching cycle begins only when the voltage between GND and SW rises above V_{LIMIT} . If Q2 consistently hits the valley current limit for 0.6ms, the buck converter enters hiccup mode and shuts down. After 3.4ms of down time, the buck converter restarts powering up. Hiccup mode reduces the power dissipation in the overcurrent condition.

The AP61204Q also has cycle-by-cycle peak current limit protection by sensing the current through the internal high-side power MOSFET, Q1, through a similar mechanism as the cycle-by-cycle valley current limit protection.

Because the $R_{DS(ON)}$ values of the power MOSFETs increase with temperature, V_{LIMIT} has a temperature coefficient of 0.4%/°C to compensate for the temperature dependency of $R_{DS(ON)}$.

7 Thermal Shutdown (TSD)

If the junction temperature of the device reaches the thermal shutdown limit of +160°C, the AP61204Q shuts down both its high-side and low-side power MOSFETs. When the junction temperature reduces to the required level (+130°C typical), the device initiates a normal power-up cycle with soft-start.

8 Power Derating Characteristics

To prevent the regulator from exceeding the maximum recommended operating junction temperature, some thermal analysis is required. The regulator's temperature rise is given by:

$$T_{RISE} = PD \cdot (\theta_{JA}) \quad \text{Eq. 3}$$

Where:

- PD is the power dissipated by the regulator
- θ_{JA} is the thermal resistance from the junction of the die to the ambient temperature

The junction temperature, T_J , is given by:

$$T_J = T_A + T_{RISE} \quad \text{Eq. 4}$$

Where:

- T_A is the ambient temperature of the environment

For the SOT563 package, the θ_{JA} is 141°C/W. The actual junction temperature should not exceed the maximum recommended operating junction temperature of +150°C when considering the thermal design.

Application Information (continued)

9 Setting the Output Voltage

The AP61204Q has adjustable output voltages, starting from 0.6V, using an external resistive divider. The resistor values of the feedback network are selected based on a design trade-off between efficiency and output-voltage accuracy. There is less current consumption in the feedback network for high resistor values, which improves efficiency at light loads. However, values too high cause the device to be more susceptible to noise affecting its output-voltage accuracy. R2 can be determined by the following equation:

$$R2 = \frac{0.6 \cdot R1}{VOUT - 0.6V} \quad \text{Eq. 5}$$

Table 1 shows a list of recommended component selections for common AP61204Q output voltages referencing Figure 1.

Table 1. Recommended Component Selections

AP61204Q						
Output Voltage (V)	R1 (kΩ)	R2 (kΩ)	L (μH)	C1 (μF)	C2 (μF)	C3 (pF)
1.0	200.0	301.0	1.0	22	22	33
1.2	200.0	200.0	1.0	22	22	33
1.5	200.0	133.0	1.0	22	22	33
1.8	200.0	100.0	1.0	22	22	33
2.5	200.0	63.2	1.0	22	22	33
3.3	200.0	44.2	1.0	22	22	33

10 Inductor

Calculating the inductor value is a critical factor in designing a buck converter. For most designs, the following equation can be used to calculate the inductor value:

$$L = \frac{VOUT \cdot (VIN - VOUT)}{VIN \cdot \Delta I_L \cdot f_{sw}} \quad \text{Eq. 6}$$

Where:

- ΔI_L is the inductor current ripple
- f_{sw} is the buck converter switching frequency

For AP61204Q, choose ΔI_L to be 30% to 50% of the maximum load current of 2A.

The inductor peak current is calculated by:

$$I_{LPEAK} = I_{LOAD} + \frac{\Delta I_L}{2} \quad \text{Eq. 7}$$

Peak current determines the required saturation current rating, which influences the size of the inductor. Saturating the inductor decreases the converter efficiency while increasing the temperatures of the inductor and the internal power MOSFETs. Therefore, choosing an inductor with the appropriate saturation current rating is important. For most applications, it is recommended to select an inductor of approximately 0.47μH to 2.2μH with a DC current rating of at least 35% higher than the maximum load current. For highest efficiency, the inductor's DC resistance should be less than 30mΩ. Use a larger inductance for improved efficiency under light-load conditions.

Application Information (continued)

11 Input Capacitor

The input capacitor reduces both the surge current drawn from the input supply as well as the switching noise from the device. The input capacitor must sustain the ripple current produced during the on-time of Q1. It must have a low ESR to minimize power dissipation due to the RMS input current.

The RMS current rating of the input capacitor is a critical parameter and must be higher than the RMS input current. As a rule of thumb, select an input capacitor with a RMS current rating greater than half of the maximum load current.

Due to large di/dt through the input capacitor, electrolytic or ceramic capacitors with low ESR should be used. If using a tantalum capacitor, it must be surge protected or else capacitor failure could occur. Using a ceramic capacitor of 10μF or greater is sufficient for most applications.

12 Output Capacitor

The output capacitor keeps the output-voltage ripple small, ensures feedback loop stability, and reduces both the overshoots and undershoots of the output voltage during load transients. During the first few microseconds of an increasing load transient, the converter recognizes the change from steady-state and sets the off-time to minimum to supply more current to the load. However, the inductor limits the change to increasing current depending on its inductance. Therefore, the output capacitor supplies the difference in current to the load during this time. Likewise, during the first few microseconds of a decreasing load transient, the converter recognizes the change from steady-state and increases the off-time to reduce the current supplied to the load. However, the inductor limits the change in decreasing current as well. Therefore, the output capacitor absorbs the excess current from the inductor during this time.

The effective output capacitance, COUT, requirements can be calculated from the equations below.

The ESR of the output capacitor dominates the output-voltage ripple. The amount of ripple can be calculated by:

$$V_{OUT_{Ripple}} = \Delta I_L \cdot \left(ESR + \frac{1}{8 \cdot f_{SW} \cdot C_{OUT}} \right) \quad \text{Eq. 8}$$

Output capacitors with large capacitance and low ESR are the best option. For most applications, a total capacitance of 22μF using ceramic capacitors is sufficient. To meet the load transient requirements, the calculated COUT should satisfy the following inequality:

$$C_{OUT} > \max \left(\frac{L \cdot I_{Trans}^2}{\Delta V_{Overshoot} \cdot V_{OUT}}, \frac{L \cdot I_{Trans}^2}{\Delta V_{Undershoot} \cdot (V_{IN} - V_{OUT})} \right) \quad \text{Eq. 9}$$

Where:

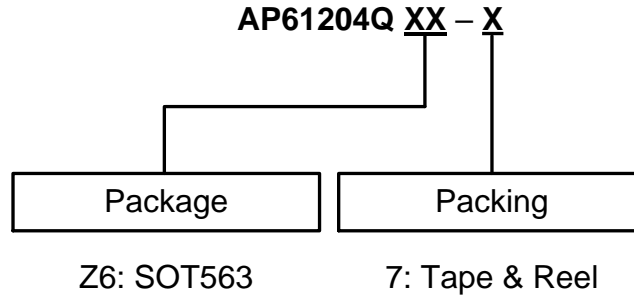
- I_{Trans} is the load transient
- ΔV_{Overshoot} is the maximum output overshoot voltage
- ΔV_{Undershoot} is the maximum output undershoot voltage

PCB Layout

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January 2024
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Ordering Information

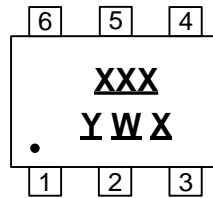


Part Number	Package	Package Code	Packing	
			Qty.	Carrier
AP61204QZ6-7	SOT563	Z6	3,000	7" Tape and Reel

Marking Information

SOT563

(Top View)



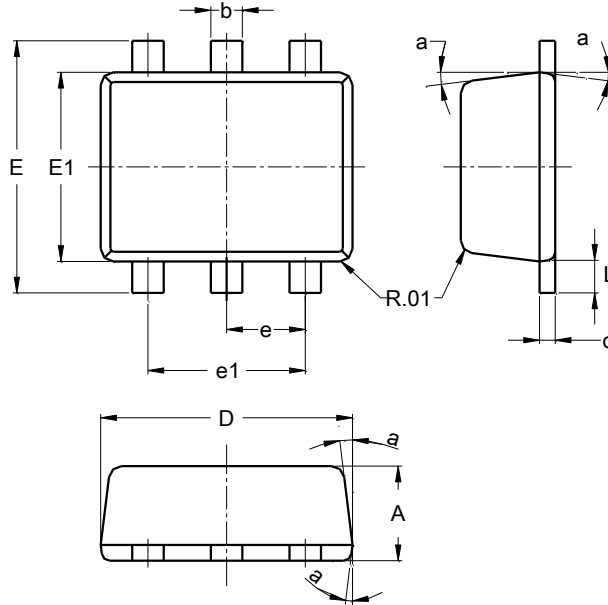
XXX: Identification Code
Y: Year 0 to 9 (ex: 4 = 2024)
W: Week: A to Z: week 1 to 26;
a to z: week 27 to 52; z represents week 52 and 53
X: Internal Code

Part Number	Package	Identification Code
AP61204QZ6-7	SOT563	GSQ

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT563

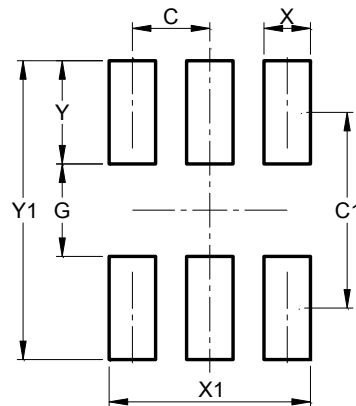


SOT563			
Dim	Min	Max	Typ
A	0.55	0.60	--
b	0.15	0.30	0.20
c	0.10	0.18	0.11
D	1.50	1.70	1.60
E	1.55	1.70	1.60
E1	1.10	1.25	1.20
e	--	--	0.50
e1	0.90	1.10	1.00
L	0.10	0.30	0.20
a	8°	9°	7°
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT563



Dimensions	Value (in mm)
C	0.500
C1	1.270
G	0.600
X	0.300
X1	1.300
Y	0.670
Y1	1.940

Mechanical Data

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.003 grams (Approximate)

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